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By: 10-21-03  
Aileen C. [Signature]

PATENT  
Attorney Docket No. 20843-000110

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the application of:

JESUS AL ORTIZ et al.

Application No.: Unassigned  
Parent Appln. No.: 09/785,973

Filed: Herewith  
Parent Filed: February 16, 2001

For: ELECTROMAGNETIC  
INTERFERENCE SHIELD OF  
ELECTRICAL CABLES AND  
CONNECTORS

Examiner: Unassigned  
Parent Exr. M. Trinh

Art Unit: Unassigned  
Parent Art: 3729

**INFORMATION DISCLOSURE  
STATEMENT**

Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

The references cited on attached form PTO-1449 are being called to the attention of the Examiner. Copies were provided in the parent application (USSN 09/785,973) and therefore are not enclosed herewith pursuant to 37 CFR 1.98(d), unless otherwise indicated. It is respectfully requested that the cited references be expressly considered during the prosecution of this application, and the references be made of record therein and appear among the "references cited" on any patent to issue therefrom.

As provided for by 37 CFR 1.97(g) and (h), no inference should be made that the information and references cited are prior art merely because they are in this statement and no representation is being made that a search has been conducted or that this statement encompasses all the possible relevant information.

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PATENT

Applicant believes that no fee is required for submission of this statement, since it is being submitted prior to the first Office Action. However, if a fee is required, the Commissioner is authorized to deduct such fee from the undersigned's Deposit Account No. 20-1430. Please deduct any additional fees from, or credit any overpayment to, the above-noted Deposit Account.

Respectfully submitted,

Dated: 10/21/03

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FORM PTO-1449 (Modified)			Attorney Docket No.: 20843-00010US		Application No. Unassigned	
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)			Applicant: JESUS AL ORTIZ et al.			
			Filing Date: Herewith		Group: Unassigned	
Reference Designation			U.S. PATENT DOCUMENTS			Page 1
Examiner Initial	Document No.	Date	Name	Class	Sub-class	Filing Date (If Appropriate)
AA	3,469,016	09/1969	Shelton			
AB	3,639,674	02/1972	Stier			
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<b>FOREIGN PATENT DOCUMENTS</b>						
	Document No.	Date	Country	Class	Sub-class	Translation (Yes/No)
<b>OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)</b>						
___ CL	Adams; <i>Taking the Mystery Out of Metallizing</i> , Vacuum Technology (November 1975) Technical Publishing Company, 4 pages total.					
___ CM	Adams; <i>Taking the Mystery Out of Metallizing-II</i> , Vacuum Technology (December 1975) Technical Publishing Company, 3 pages total.					
___ CN	Adams; <i>Taking the Mystery Out of Metallizing-III</i> , Vacuum Technology (February 1976) Technical Publishing Company, 4 pages total.					
___ CO	Gabower, <i>Thermoformed Vacuum-Metallized Inserts For EMI Shielding</i> , ITEM (1995) The International Journal of EMC, Robar Industries, Inc., pp. 120, 122, 123, and 127.					

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		Filing Date: Herewith	Group: Unassigned
_____ CP	Gabower, <i>Thermoformed Vacuum Metallized Inserts For EMI Shielding of Electronic Devices</i> , Consumer Electronics Show, Flamingo Hilton and Tower, Las Vegas, Nevada, pp. 151-158.		
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_____ DD	<i>6100 Thermoformable EMI-Shielding Material</i> , Minnesota Mining & Mfg. Co. (1994) 2 pages total.		
_____ DE	<i>Orion® Designs Economical EMI Shielding Box Without Cutting Corners</i> , Product Brochure, Orion® Industries Incorporated, 1 page total.		
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_____ DI	<i>Ultrasonic Welders Advance Clamshell-Sealing Process</i> , Packaging (October 1994) pp. 78-21.		
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_____ DL	<i>Silver Shielding for the Highest Performance</i> , Swift Textile Metalizing Corporation, ITEM (1995) pp. 11, 15, 109, 112, 113, 115, 116, 212, 213, 267, 269.		
EXAMINER		DATE CONSIDERED	

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.